



40V +175°C N-CHANNEL ENHANCEMENT MODE MOSFET PowerDI5060-8

Product Summary

BV _{DSS}	R _{DS(ON)} Max	I _D Max Tc = +25°C
40V	$7.3 \text{m}\Omega$ @ V _{GS} = 10V	73.0A
40 V	$12m\Omega$ @ $V_{GS} = 4.5V$	58.0A

Features

- Rated to +175°C Ideal for High Ambient Temperature Environments
- 100% Unclamped Inductive Switching (UIS) Test in Production Ensures More Reliable and Robust End Application
- High Conversion Efficiency
- Low RDS(ON) Minimizes Power Losses
- Wettable Flank for Improved Optical Inspection
- Fast Switching Speed
- Low Input Capacitance
- Lead-Free Finish; RoHS Compliant (Notes 1 & 2)
- Halogen and Antimony Free. "Green" Device (Note 3)
- The DMTH47M2LPSWQ is suitable for automotive applications requiring specific change control; this part is AEC-Q101 qualified, PPAP capable, and manufactured in IATF 16949 certified facilities.

https://www.diodes.com/quality/product-definitions/

Description and Applications

This MOSFET is designed to meet the stringent requirements of automotive applications. It is qualified to AEC-Q101, supported by a PPAP and is ideal for use in:

- High frequency switching
- Synchronous rectifications
- DC-DC converters

Mechanical Data

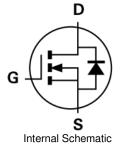
- Package: PowerDI[®]5060-8
- Package Material: Molded Plastic, "Green" Molding Compound.
 UL Flammability Classification Rating 94V-0
- Moisture Sensitivity: Level 1 per J-STD-020
- Terminal Finish Matte Tin Annealed over Copper Leadframe.
 Solderable per MIL-STD-202, Method 208 3
- Weight: 0.097 grams (Approximate)

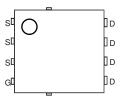


PowerDI5060-8 (SWP) (Type UX)



Bottom View





Top View Pin Configuration

Ordering Information (Note 4)

Part Number	Paakaga	Packing		
Part Number	Package	Qty.	Carrier	
DMTH47M2LPSWQ-13	PowerDI5060-8 (SWP) (Type UX)	2500	Tape & Reel	

Notes:

- 1. EU Directive 2002/95/EC (RoHS), 2011/65/EU (RoHS 2) & 2015/863/EU (RoHS 3) compliant. All applicable RoHS exemptions applied.
- 2. See https://www.diodes.com/quality/lead-free/ for more information about Diodes Incorporated's definitions of Halogen- and Antimony-free, "Green" and Lead-free.
- 3. Halogen- and Antimony-free "Green" products are defined as those which contain <900ppm bromine, <900ppm chlorine (<1500ppm total Br + Cl) and <1000ppm antimony compounds.
- 4. For packaging details, go to our website at https://www.diodes.com/design/support/packaging/diodes-packaging/.

Marking Information



H = Manufacturer's Marking
 H47M2LS = Product Type Marking Code
 YYWW = Date Code Marking
 YY = Year (ex: 22 = 2022)
 WW = Week (01 to 53)

PowerDI is a registered trademark of Diodes Incorporated.



Maximum Ratings (@ $T_A = +25^{\circ}C$, unless otherwise specified.)

Characteristic	Symbol	Value	Unit	
Drain-Source Voltage		VDSS	40	V
Gate-Source Voltage		V_{GSS}	±20	V
Continuous Drain Current (Note 6)	$T_C = +25$ °C $T_C = +100$ °C	ΙD	73.0 51.0	А
Maximum Continuous Body Diode Forward Current (Note 6)	Is	73.0	Α	
Pulsed Drain Current (10µs Pulse, Duty Cycle = 1%)		l _{DM}	292	Α
Pulsed Body Diode Forward Current (10µs Pulse, Duty Cycle = 1%)		lsм	292	Α
Avalanche Current, L = 0.1mH		las	22.1	Α
Avalanche Energy, L = 0.1mH		Eas	24.4	mJ

Thermal Characteristics

Characteristic		Symbol	Value	Unit
Total Power Dissipation (Note 5)	T _A = +25°C	PD	3.8	W
Thermal Resistance, Junction to Ambient (Note 5)	Steady State	Reja	39.4	°C/W
Total Power Dissipation (Note 6)	T _C = +25°C	PD	68	W
Thermal Resistance, Junction to Case (Note 6)	·	Rejc	2.2	°C/W
Operating and Storage Temperature Range		TJ, TSTG	-55 to +175	°C

Electrical Characteristics (@TA = +25°C, unless otherwise specified.)

Characteristic	Symbol	Min	Тур	Max	Unit	Test Condition	
OFF CHARACTERISTICS (Note 7)			- 7 P	1110271			
Drain-Source Breakdown Voltage	BV _{DSS}	40	_	_	V	$V_{GS} = 0V, I_D = 250\mu A$	
Zero Gate Voltage Drain Current	IDSS		_	1	μA	V _{DS} = 32V, V _{GS} = 0V	
Gate-Source Leakage	Igss	_	_	±100	nA	$V_{GS} = \pm 20V$, $V_{DS} = 0V$	
ON CHARACTERISTICS (Note 7)	•						
Gate Threshold Voltage	V _{GS(TH)}	1.2	_	2.3	V	$V_{DS} = V_{GS}$, $I_D = 250\mu A$	
Static Drain-Source On-Resistance	Dagger	_	5.7	7.3	mΩ	V _G S = 10V, I _D = 20A	
Static Drain-Source On-nesistance	RDS(ON)	_	8.1	12	11122	$V_{GS} = 4.5V, I_{D} = 10A$	
Diode Forward Voltage	V_{SD}	_	0.8	1.2	V	V _{GS} = 0V, I _S = 20A	
DYNAMIC CHARACTERISTICS (Note 8)	•						
Input Capacitance	Ciss		891			V _{DS} = 20V, V _{GS} = 0V, f = 1MHz	
Output Capacitance	Coss		490	_	pF		
Reverse Transfer Capacitance	Crss	_	14.8	_			
Gate Resistance	R_g	_	1.87	_	Ω	$V_{DS} = 0V$, $V_{GS} = 0V$, $f = 1MHz$	
Total Gate Charge (VGS = 10V)	Qg	_	12.6	_		V _{DD} = 20V, I _D = 20A	
Total Gate Charge (VGS = 4.5V)	Qg	_	5.9	_	nC		
Gate-Source Charge	Q _{gs}	_	2.4	_	IIC		
Gate-Drain Charge	Q_{gd}	_	1.7	_			
Turn-On Delay Time	t _D (ON)	_	3.9	_		$V_{DD} = 20V, V_{GS} = 10V,$ $R_g = 3\Omega, I_D = 20A$	
Turn-On Rise Time	tR	_	5.4	_			
Turn-Off Delay Time	tD(OFF)	_	15.4	_	ns		
Turn-Off Fall Time	tF	_	8.5	_			
Body Diode Reverse Recovery Time	t _{RR}		56.6	_	ns	1 004 4:/4+ 1004/	
Body Diode Reverse Recovery Charge	Qrr	_	40.0		$_{\rm nC}$ I _F = 20A, di/dt = 100A/µs		

 Device mounted on FR-4 substrate PC board, 2oz copper, with thermal bias to bottom layer 1inch square copper plate.
 Thermal resistance from junction to soldering point (on the exposed drain pad).
 Short duration pulse test used to minimize self-heating effect.
 Guaranteed by design. Not subject to product testing. Notes:

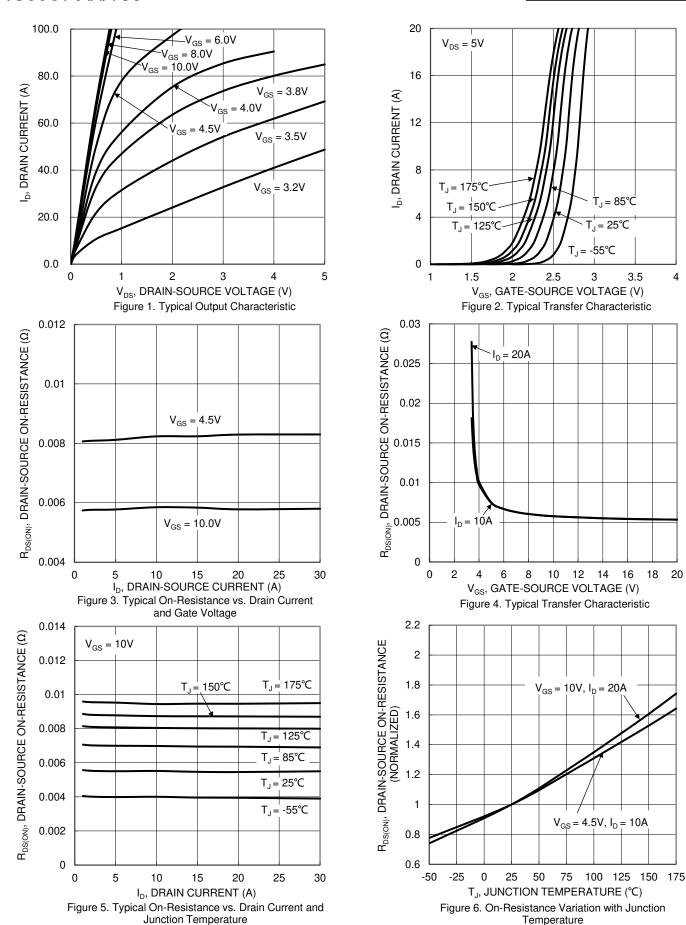


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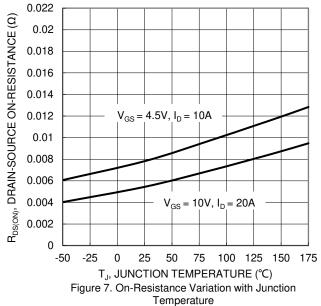
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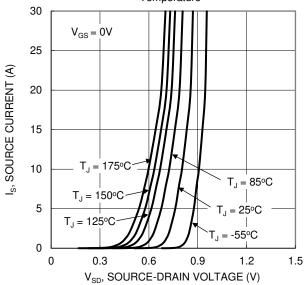


Figure 9. Diode Forward Voltage vs. Current

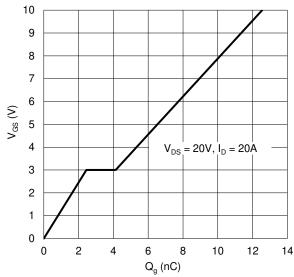


Figure 11. Gate Charge

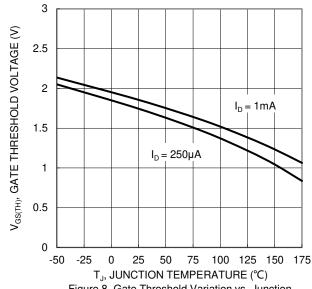


Figure 8. Gate Threshold Variation vs. Junction Temperature

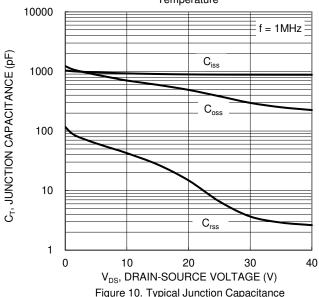


Figure 10. Typical Junction Capacitance

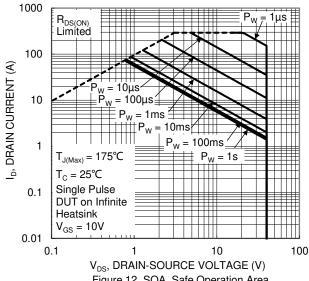


Figure 12. SOA, Safe Operation Area



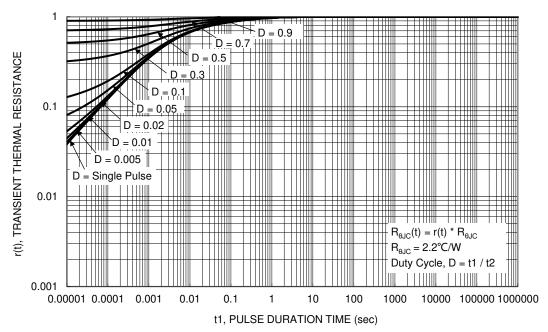


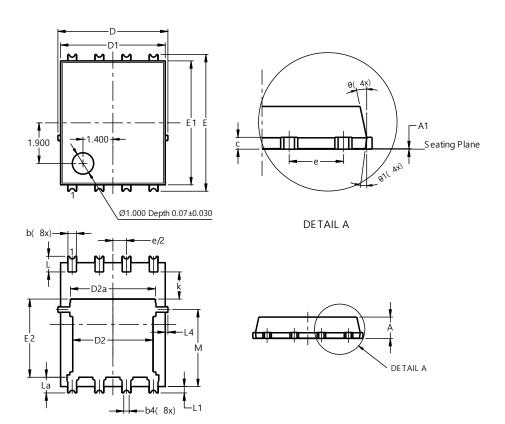
Figure 13. Transient Thermal Resistance



Package Outline Dimensions

Please see http://www.diodes.com/package-outlines.html for the latest version.

PowerDI5060-8 (SWP) (Type UX)

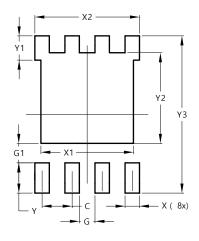


PowerDI5060-8 (SWP)				
(Type UX)				
Dim	Min	Max	Тур	
Α	0.90	1.10	1.00	
A 1	0	0.05		
b	0.30	0.50	0.41	
b2	0.20	0.35	0.25	
b4).25REF		
С	0.230	0.330	0.277	
D		.15 BS0		
D1	4.70	5.10	4.90	
D2	3.56	3.96	3.76	
D2a	3.78	4.18	3.98	
Е	6	.40 BS0		
E1	5.60	6.00	5.80	
E2	3.46	3.86	3.66	
E2a	4.195	4.595	4.395	
е	1.27BSC			
k	1.05			
L	0.635	0.835	0.735	
La	0.635	0.835	0.735	
L1	0.200	0.400	0.300	
L1a	0.050REF			
L4	0.025	0.225	0.125	
М	3.205	4.005	3.605	
θ	10°	12°	11°	
θ1	6°	8°	7°	
All Dimensions in mm				

Suggested Pad Layout

Please see http://www.diodes.com/package-outlines.html for the latest version.

PowerDI5060-8 (SWP) (Type UX)



Dimensions	Value		
Dillicitatoria	(in mm)		
С	1.270		
G	0.660		
G1	0.820		
X	0.610		
X1	4.100		
X2	4.420		
Υ	1.270		
Y1	1.020		
Y2	3.810		
Y3	6.610		



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